

Electronic Patent Application Fee Transmittal

Application Number:	10531553			
Filing Date:	02-May-2006			
Title of Invention:	Isostatic pressure assisted wafer bonding method			
First Named Inventor/Applicant Name:	Vitali Nesterenko			
Filer:	Kevin Thomas Bastuba/Katrina Leonardi			
Attorney Docket Number:	0321.68367			
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U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 2 months with \$0 paid	2252	1	245	245

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	2801	1	405	405
Total in USD (\$)				650